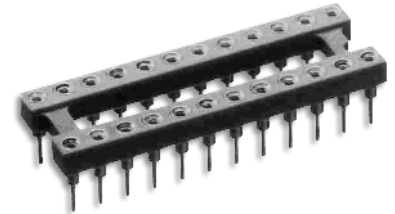




Series 518 Open Frame Socket w/Collet Contacts & Solder Pin Tails

FEATURES

- Open Frame allows Efficient Utilization of Board Space with Optimized Cooling
- Choose from Several Pin Styles
- Compatible with Automatic Insertion Equipment
- Side-to-side and End-to-end Stackable



GENERAL SPECIFICATIONS

- **BODY MATERIAL:** Black UL 94V-0 Glass-filled 4/6 Nylon
- **PIN BODY:** Brass 360 1/2-hard per UNS C36000 ASTM B16-00
- **PIN BODY PLATING:** 10 μ [0.25 μ] min. Au per MIL-G-45204
 –OR– 200 μ [5.08 μ] min. 93/7 Sn/Pb per ASTM B545
 –OR– 200 μ [5.08 μ] min. Sn per ASTM B545 Type 1 over 100 μ [2.54 μ] min. Ni per SAE AMS-QQ-N-290
- **4-FINGER COLLET CONTACT:** BeCu per UNS C17200 ASTM B194-01
- **CONTACT PLATING:** 200 μ [5.08 μ] min. 93/7 Sn/Pb per ASTM B545
 –OR– 200 μ [5.08 μ] min. Sn per ASTM B545 Type 1
 –OR– 10 μ [0.25 μ] Au per MIL-G-45204 over 50 μ [1.27 μ] min. Ni per SAE AMS-QQ-N-290
- **AVAILABLE PLATING:** heavy Au 30 μ [0.76 μ]
- **CONTACT CURRENT RATING:** 3 amps
- **OPERATING TEMPERATURE:** 221°F [105°C] for Sn and Sn/Pb plating, 257°F [125°C] for Au plating
- **INSERTION FORCE:** 180g/pin
- **WITHDRAWAL FORCE:** 90g/pin
- **NORMAL FORCE:** 140g/pin
- **MIDGET PIN INSERTION FORCE:** 370g/pin
- **MIDGET PIN WITHDRAWAL FORCE:** 150g/pin
- **MIDGET PIN NORMAL FORCE:** 240g/pin, based on a 0.018 [0.46] dia. test lead
- **ACCEPTS LEAD LENGTHS:** from 0.100 [2.54] min. and 0.015-0.025 [0.38-0.64] dia.
- **ACCEPTS MIDGET PIN LEAD LENGTHS:** from 0.080 [2.03] and up to 0.022 [0.56] dia.

ORDERING INFORMATION

XX-X 518-X XXX XXX

Additional Options

- H = Heavy Au on Collet
- T = Sn on Collet
- TL = Sn/Pb on Collet
- M = Midget Solder Tail (Au Collet, Sn Shell Only)
- MTL = Midget Solder Tail (Au Collet, Sn/Pb Shell Only)
- E = Extra Long Solder Tail

Plating *

- 0 = Au Collet, Sn Shell
- OTL = Au Collet, Sn/Pb Shell
- 1 = Au Collet & Shell

Termination

- 1 = Solder Pin Tail

Series

Row-to-Row Spacing, "Y" Dim.

- 3 = 0.300 [7.62]
- 4 = 0.400 [10.16]
- 6 = 0.600 [15.24]
- 9 = 0.900 [22.86]

No. of Pins

(See Table)

* Consult Factory for Additional Plating Options

MOUNTING CONSIDERATIONS

- **SUGGESTED PCB HOLE SIZE FOR SOLDER PIN TAIL AND EXTRA LONG PIN:** 0.030 \pm 0.002 [0.76 \pm 0.05] dia.
- **SUGGESTED PCB HOLE SIZE FOR MIDGET PIN:** 0.040 \pm 0.002 [1.02 \pm 0.05] dia.

ALL DIMENSIONS: INCHES [MILLIMETERS]

ALL TOLERANCES: \pm 0.005 [0.13] UNLESS OTHERWISE SPECIFIED

OPEN FRAME COLLET SOCKET w/SOLDER PIN TAILS, SEE [DATA SHEET 12017](#)

OPEN FRAME SURFACE MOUNT SOCKET, SEE [DATA SHEET 12018](#)

OPEN FRAME COLLET CAPACITOR SOCKET w/SOLDER PIN, SEE [DATA SHEET 12026](#)

OPEN FRAME COLLET CAPACITOR SOCKET w/WIRE WRAP, SEE [DATA SHEET 12027](#)

CONSULT FACTORY FOR OTHER SIZES AND CONFIGURATIONS

CUSTOMIZATION: ARIES SPECIALIZES IN CUSTOM DESIGN AND PRODUCTION. SPECIAL MATERIALS, PLATINGS, SIZES, AND CONFIGURATIONS CAN BE FURNISHED, DEPENDING ON QUANTITY.

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